L Number	Hits	Search Text	DB	Time Stamp
1	4516	((438/464,716,618) or 118/64,666,667,500)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 14:47
2	370	(((438/464,716,618) or (118/64,666,667,500)).CCLS.) and temperature near5 control	USPAT	2003/03/28 14:33
3	169	((((438/464,716,618) or 118/64,666,667,500)).CCLS. and temperature near5 control) and detect$3	USPAT	2003/03/28 14:43
4	121	(((((438/464,716,618) or (118/64,666,667,500)).CCLS. and temperature near5 control) and detect$3) and (semiconductor wafer)	USPAT	2003/03/28 14:46
5	77	((((((438/464,716,618) or (118/64,666,667,500)).CCLS.) and temperature near5 control) and detect$3) and (semiconductor wafer)) and range	USPAT	2003/03/28 14:47
6	76	(((((438/464,716,618) or 118/64,666,667,500)).CCLS.) and temperature near5 control) and detect$3) and (semiconductor wafer)) and range) and heat$3	USPAT	2003/03/28 14:47

C:\APPS\EAST\Workspaces\Wafer handling.wsp